

Bienvenue sur O-MORT

O-Lead Leading s'efforce d'être votre partenaire de solution unique dans la chaîne d'approvisionnement EMS, y compris la conception de la PCB, la fabrication de circuit imprimé et l'assemblage PCB (PCBA) .Nous fournissons une partie de la technologie PCB la plus avancée, notamment des PCB HDI, des PCB multicouches, des PCBs flexibles rigides Nous pouvons supporter du prototype de virage rapide à la production moyenne et de masse.

En général, nos clients mondiaux sont très impressionnés par nos services: réponse rapide, prix compétitif et engagement de la qualité.LI PRODUIRE Un service technique plus précieux et une solution globale est la voie à suivre vers l'avant.

En ce qui concerne l'avenir, O-leader se concentrera sur l'innovation et le développement de la technologie de fabrication de l'électronique comme toujours et rendra des efforts persistants sur le service unique de PCB & PCBA afin de fournir des services de première classe et de créer plus de valeur pour nos clients.[Fabricant de l'Assemblée PCB Chine](#)

Description du produit

Détails rapides

PCB P / N	CD539
Compte de couche	2L
Matériel	FR-4 TG130
Plancher	0.8mm
cuivre	2 / 2Oz
La plus petite taille de trou	0.5mm
Nombre de trous (PCS)	477
ligne w / s	12 / 12mil
Contrôle d'impédance. Y / N (TOL%)	N
Finition de surfaceg	Hasl-lf
Sérigraphie de masque de soudure	Blanc / n / a
Taille d'une planche unique	Dim X (mm): 301; Dim y (mm): 75.8
Panneau	Dim X (mm): 320; Dim y (mm): 240; Nombre d'onduleurs: 3
Spécial: masque pelable	N
Routage / poinçonnage	Cnc

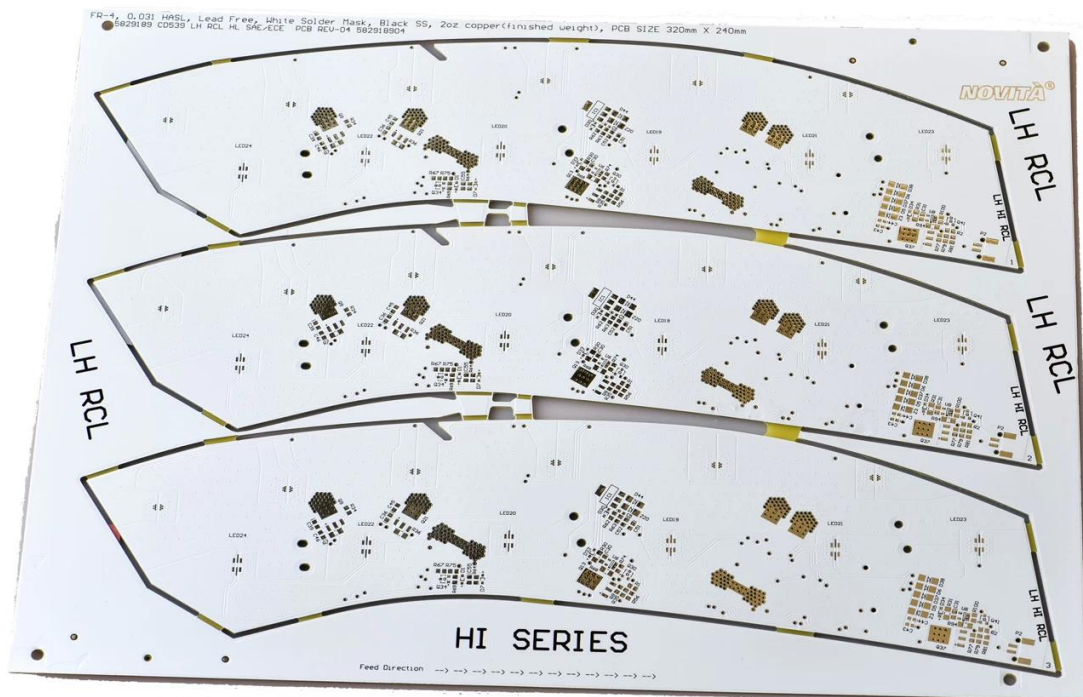
La capacité de production

16 ans de fabrication professionnelle du conseil d'administration d'OEM ([Layout PCB Fabricant Chine](#))

Objet	2014		2015 ~ 2016		2017 ~ 2018	
	Le volume	Goûter	Le volume	Goûter	Le volume	Goûter
Compte de couche	32	42	38	44	42	48
Ligne min / espace (µm)	50/50	40/45	40/45	40/40	35/40	35/35

Diamètre du trou de forage min (mm)	0,15	0.10	0,15	0.10	0,15	0.10
Ratio de format de PTH	14: 1	16: 1	16: 1	18: 1	18: 1	20: 1
N + c + n	4 + C + 4	5 + C + 5	5 + C + 5	6 + C + 6	5 + C + 5	6 + C + 6
Toute interconnexion de couche	5 + 2 + 5	6 + 2 + 6	5 + 2 + 5	6 + 2 + 6	5 + 2 + 5	6 + 2 + 6
Remplissage de plaques via	OUI	-	OUI	-	OUI	-
Min. Épaisseur de base (exclure le cuivre) (µm)	50	40	40	30	40	30
Min. Diamètre de perceuse au laser (µm)	75	65	65	50	50	40
Via sur le trou enterré / empilé via	OUI	-	OUI	-	OUI	-
Matériel	FR4, Megtron, Nelco, Rogers, Cuivre lourd, etc.					
PCB de condensateur intégré	OUI	-	OUI	-	OUI	-
Processus de surface	HASL sans plomb, Enig, OSP, argent immersion, étain d'immersion, or flash, placage doré, placage doré dur sélectif, masque de soudure pelable, encre de carbone					

O-LEADING
To Be Reliable, To Be Valuable



www.o-leading.com

Notre équipe



Factory PCB



Automatic vacuum press machine



Drilling Machine



Pattern Plating Machine



Scrubbing Machine



Developing Machine



Routing Machine



High-speed flying probe machine



E-test Machine

Factory SMT



Certifications





Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

Page 1 of 6

O-LEADING SUPPLY CHAIN (HK) CO., LIMITED

1313.FLOOR 13, FORTUNE BUILDING, DANSHUI TOWN, HUIYANG DISTRICT, HUIZHOU, GUANGDONG, CHINA

The following sample(s) was/were submitted and identified on behalf of the clients as : OSP

SGS Job No. : RP19-005089 - SZ

Date of Sample Received : 22 Mar 2019

Testing Period : 22 Mar 2019 - 30 Mar 2019

Test Requested : Selected test(s) as requested by client.

Test Method : Please refer to next page(s).

Test Results : Please refer to next page(s).

Conclusion : Based on the performed tests on submitted sample(s), the results of Lead, Mercury, Cadmium, Hexavalent chromium, Polybrominated biphenyls (PBBs), Polybrominated diphenyl ethers (PBDEs) and Phthalates such as Bis(2-ethylhexyl) phthalate (DEHP) , Butyl benzyl phthalate (BBP), Dibutyl phthalate (DBP) , and Diisobutyl phthalate (DIBP) comply with the limits as set by RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU.

Signed for and on behalf of
SGS-CSTC Standards Technical Services Co., Ltd. Shenzhen Branch

Tina Fan
Approved Signatory



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For more information, please contact our sales representative. Please contact us at telephone: (86-755) 8307 1442 or email: CHN.Sales@sgs.com
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Test Report

No. SZXEC1900530401

Date: 30 Mar 2019

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Test Results :

Test Part Description :

Specimen No.	SGS Sample ID	Description
SN1	SZX19-005304.001	Green"PCB"

Remarks :

- (1) 1 mg/kg = 1 ppm = 0.0001%
- (2) MDL = Method Detection Limit
- (3) ND = Not Detected (< MDL)
- (4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method : With reference to IEC 62321-4:2013+A1:2017, IEC 62321-5:2013, IEC 62321-7-2:2017, IEC 62321-6:2015 and IEC 62321-8:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

Test item(s)	Limit	Unit	MDL	Q/Z
Cadmium (Cd)	100	mg/kg	2	ND
Lead (Pb)	1,000	mg/kg	2	8
Mercury (Hg)	1,000	mg/kg	2	ND
Hexavalent Chromium (Cr(VI))	1,000	mg/kg	8	ND
Sum of PBBs	1,000	mg/kg	-	ND
Monobromobiphenyl	-	mg/kg	5	ND
Dibromobiphenyl	-	mg/kg	5	ND
Tribromobiphenyl	-	mg/kg	5	ND
Tetrabromobiphenyl	-	mg/kg	5	ND
Pentabromobiphenyl	-	mg/kg	5	ND
Hexabromobiphenyl	-	mg/kg	5	ND
Heptabromobiphenyl	-	mg/kg	5	ND
Octabromobiphenyl	-	mg/kg	5	ND
Nonabromobiphenyl	-	mg/kg	5	ND
Decabromobiphenyl	-	mg/kg	5	ND
Sum of PBDEs	1,000	mg/kg	-	ND
Monobromodiphenyl ether	-	mg/kg	5	ND
Dibromodiphenyl ether	-	mg/kg	5	ND
Tribromodiphenyl ether	-	mg/kg	5	ND
Tetrabromodiphenyl ether	-	mg/kg	5	ND
Pentabromodiphenyl ether	-	mg/kg	5	ND



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ZPMV2.E490354 - WIRING, PRINTED - COMPONENT

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

O-LEADING SUPPLY CHAIN (HK) CO LTD

E490354

ROOM 1205, 12/F
TAI SANG BANK BLDG
130-132 DES VOEUS ROAD
CENTRAL, HONG KONG

Type	Cond Width		Cond Thk mic(mil)	SS/ DS/ DSO	Max		Max		Meets UL796 Class	C T DSR	I
	Min	Min			Area	Solder	Oper	Flame			
	mm(in)	mm(in)			Diam	Limits	Temp	Temp			
Multilayer (mass laminate) printed wiring boards.											
O-LEADING-401	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	12.7 (0.5)	260	10	130	V-0	-	-
O-LEADING-407	0.08 (0.003)	0.2 (0.008)	17 (0.67)	DS	9.7 (0.4)	260	10	130	V-0	All	-
Multilayer printed wiring boards.											
O-LEADING-408	0.125 (0.005)	0.125 (0.005)	12 (0.47) Int:136	DS	50.8 (2.0)	280	20	130	V-0	All	*
Single layer printed wiring boards.											
O-LEADING-002	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	105	V-0	All	-
O-LEADING-003	0.38 (0.015)	1.14 (0.045)	34 (1.34)	SS	19.1 (0.8)	260	10	130	V-0	▲	-
O-LEADING-033	0.15 (0.006)	0.3 (0.012)	34 (1.34)	SS	25.4 (1.0)	260	10	120	V-0	All	-
O-LEADING-205	0.1 (0.004)	0.3 (0.012)	34 (1.34)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-206	0.15 (0.006)	0.33 (0.013)	17 (0.67)	DS	69.6 (2.7)	260	10	130	V-0	All	-
O-LEADING-D01	0.14 (0.006)	0.15 (0.006)	33 (1.30)	DS	25.4 (1.0)	260	10	130	V-0	All	*
O-LEADING-S01	0.25 (0.010)	0.25 (0.010)	17 (0.67)	SS	25.4 (1.0)	260	4	130	V-0	All	*

WIRING, PRINTED - COMPONENT | UL Product iQ

O-LEADING-S02	0.2 (0.008)	0.2 (0.008)	17 (0.67)	SS	25.4 (1.0)	260	4	130	HB	▲
O-LEADING-S03	0.25 (0.010)	0.25 (0.010)	34 (1.34)	SS	25.4 (1.0)	260	4	130	V-0	All

* - CTI marking is optional and may be marked on the printed wiring board.

Marking: Company name or file number and type designation. May be followed by a suffix to denote factory identification or burning test classification.

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Emballage et livraison

Shipping service



Quick Turn Lead Time		
Layer Count:	Lead Tim	Special Requirement
1L/2L	2-3days	24 Hours,48 Hours
4L	3-4days	48 Hours
6L	4-5days	72 Hours
8L	5-6days	NA
10L	6-7days	NA
12L	7-8days	NA
14L	8-9days	NA

Standard Lead Time		
Layer Count:	Sample Lead Time	Volume order lead time
2L	4 days	10 days
4L	5 days	11 days
6L	6 days	12 days
8L	8 days	14 days
10L	10 days	16 days
12L	12 days	18 days
14L	14 days	20 days
16-32L	18 days	24 days

Capacité du processus

Capacités de production de PCB

Compte de couche: 1Layer-32Layer

Épaisseur de cuivre finie: 1 / 3oz-12oz

Largeur de ligne min / espacement interne: 3.0mil / 3.0mil

Largeur de ligne min / espacement externe: 4.0mil / 4.0mil

Ratio de format Max: 10: 1

Épaisseur du tableau: 0.2mm-5,0mm

Taille du panneau Max (pouces): 635 * 1500mm

Taille du trou foré minimum: 4mil

Tolérance du trou porté: +/- 3mil

Blind / enterré vias (types All): oui

Via remplissage (conducteur, non conducteur): oui

Matériau de base: FR-4, FR-4HIGHT TG.HALOGEN MATERIAU GRATUIT, ROGERS, BASE

D'ALUMINIUM,Polyimide,

Cuivre lourd

Finitions superficielles: HASL, OSP, ENIG, HAL-LF, LMMERSION Silver,Tin de Immersion, doigts d'or, encre de carbone

Capacités de production SMT

Matériel PCB: FR-4, CEM-1, CEM-3, tableau à base d'aluminium

Max PCB Taille: 510x460mm

Taille MIN PCB: 50x50mm

Épaisseur PCB: 0.5mm-4,5mm

Épaisseur du tableau: 0.5-4mm

Min Composants Taille: 0201

Composant de taille de puce standard: 0603 et plus grand

Composant Max Hauteur: 15mm

Min Pitch à plomb: 0.3mm

MIN BGA BALL PITCH: 0.4mm

Précision de placement: +/- 0.03mm